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ON Semiconductor®

NDS351N N-Channel Logic Level Enhancement Mode Field Effect Transistor

General Description

package.

These N-Channel logic level enhancement mode power

field effect transistors are produced using ON

Semiconductor's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage

applications in notebook computers, portable phones,

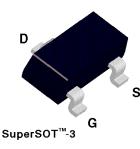
PCMCIA cards, and other battery powered circuits

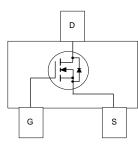
where fast switching, and low in-line power loss are

needed in a very small outline surface mount

Features

- 1.1A, 30V. $R_{DS(ON)} = 0.25\Omega$ @ $V_{GS} = 4.5V$.
- Proprietary package design using copper lead frame for superior thermal and electrical capabilities.
- High density cell design for extremely low R_{DS(ON)}.
- Exceptional on-resistance and maximum DC current capability.
- Compact industry standard SOT-23 surface mount package.





Absolute Maximum Ratings $T_{4} = 25^{\circ}C$ unless otherwise noted

| Symbol | Parameter | | NDS351N | Units |
|---------------------|---|-----------|------------|-------|
| V _{DSS} | Drain-Source Voltage | | 30 | V |
| V _{GSS} | Gate-Source Voltage - Continuous | | 20 | V |
| I _D | Maximum Drain Current - Continuous | (Note 1a) | ± 1.1 | А |
| | - Pulsed | | ± 10 | |
| P _D | Maximum Power Dissipation | (Note 1a) | 0.5 | W |
| | | (Note 1b) | 0.46 | |
| T_,T _{stg} | Operating and Storage Temperature Range | | -55 to 150 | °C |
| THERMA | L CHARACTERISTICS | | | |
| R _{θJA} | Thermal Resistance, Junction-to-Ambient | | 250 | °C/W |
| θ1Υ | | (Note 1a) | | |
| R _{θJC} | Thermal Resistance, Junction-to-Case | (Note 1) | 75 | °C/W |

| Symbol | Parameter | Conditions | | Min | Тур | Max | Units |
|---------------------|-----------------------------------|--|-----------------------|-----|-------|------|-------|
| OFF CHA | RACTERISTICS | | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | $V_{GS} = 0 V, I_{D} = 250 \mu A$ | | 30 | | | V |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$ | | | | 1 | μA |
| | | | T _J =125°C | | | 10 | μA |
| | Gate - Body Leakage, Forward | $V_{GS} = 12 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$ | | | | 100 | nA |
| I _{gssr} | Gate - Body Leakage, Reverse | $V_{GS} = -12 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$ | | | | -100 | nA |
| ON CHAR | ACTERISTICS (Note 2) | | | | | | |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | V _{DS} = V _{GS} , I _D = 250 μA | | 0.8 | 1.6 | 2 | V |
| | | | T _J =125°C | 0.5 | 1.3 | 1.5 | |
| R _{DS(ON)} | Static Drain-Source On-Resistance | $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 1.1 \text{ A}$ | | | 0.185 | 0.25 | Ω |
| | | | T _J =125°C | | 0.26 | 0.37 | |
| | | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 1.4 \text{ A}$ | | | 0.135 | 0.16 | |
| D(ON) | On-State Drain Current | $V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$ | | 5 | | | Α |
| g _{fs} | Forward Transconductance | $V_{DS} = 5 V, I_{D} = 1.1 A$ | | | 2.5 | | S |
| DYNAMIC | CHARACTERISTICS | | | | | | |
| C _{iss} | Input Capacitance | $V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz | | | 140 | | pF |
| C _{oss} | Output Capacitance | | | | 80 | | pF |
| C _{rss} | Reverse Transfer Capacitance | | | | 18 | | pF |
| SWITCHI | NG CHARACTERISTICS (Note 2) | | | | | | |
| t _{d(on)} | Turn - On Delay Time | $V_{DD} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 50 \Omega$ | | | 9 | 15 | ns |
| t _r | Turn - On Rise Time | | | | 16 | 30 | ns |
| t _{d(off)} | Turn - Off Delay Time | | | | 26 | 50 | ns |
| t _r | Turn - Off Fall Time | | | | 19 | 40 | ns |
| Q _g | Total Gate Charge | $V_{\rm DS} = 10 \text{ V}, \text{ I}_{\rm D} = 1.1 \text{ A},$ $V_{\rm GS} = 5 \text{ V}$ | | | 2 | 3.5 | nC |
| Q _{gs} | Gate-Source Charge | | | | | 1 | nC |
| Q_{gd} | Gate-Drain Charge | | | | | 2 | nC |

| Electrical Characteristics (T _A = 25°C unless otherwise noted) | | | | | | | | | |
|---|---|--|-----|-----|-----|-------|--|--|--|
| Symbol | Parameter Conditions | | Min | Тур | Max | Units | | | |
| DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS | | | | | | | | | |
| I _s | Maximum Continuous Drain-Source Diode Forward Current | | | | 0.6 | А | | | |
| I _{SM} | Maximum Pulsed Drain-Source Diode Forward Current | | | | 5 | А | | | |
| V _{SD} | Drain-Source Diode Forward Voltage | $V_{GS} = 0 \text{ V}, I_{S} = 1.1 \text{ A}$ (Note 2) | | 0.8 | 1.2 | V | | | |
| Notes: | • | - | • | | • | • | | | |

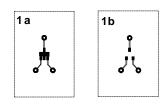
1. R_{gub} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{gub} is guaranteed by design while R_{gub} is determined by the user's board design.

 $P_D(t) = \frac{T_J - T_A}{R_{0J} \, \text{\AA}} = \frac{T_J - T_A}{R_{0J} \, \text{\AA}^R_{0C} \, \text{\AA}^{(t)}} = I_D^2(t) \times R_{DS \, (ON)} \hat{\mathbf{g}}_{TJ}$

Typical $\rm R_{_{H^{JA}}}$ using the board layouts shown below on 4.5"x5" FR-4 PCB in a still air environment:

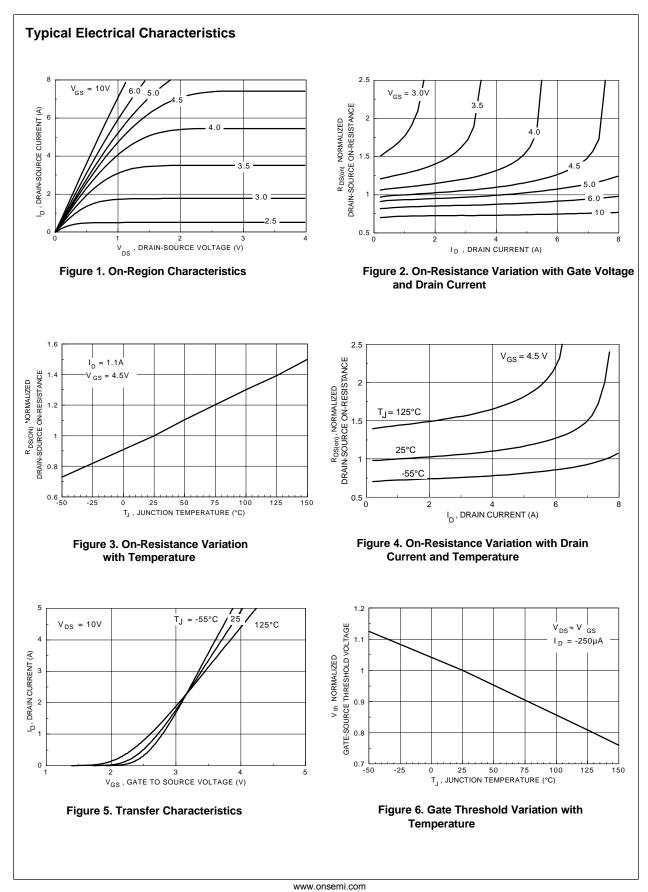
a. 250°C/W when mounted on a 0.02 in² pad of 2oz cpper.

b. 270°C/W when mounted on a 0.001 in² pad of 2oz cpper.

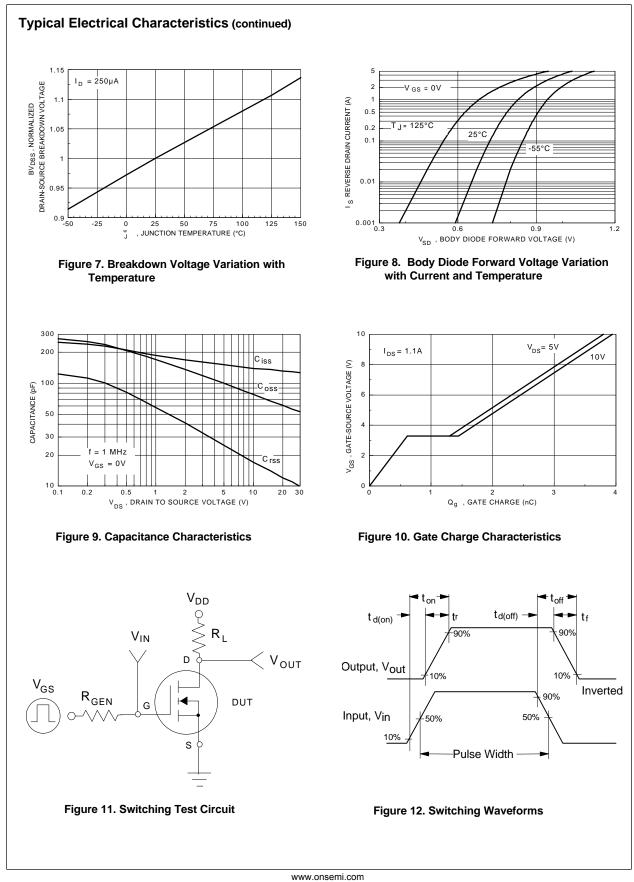


Scale 1 : 1 on letter size paper

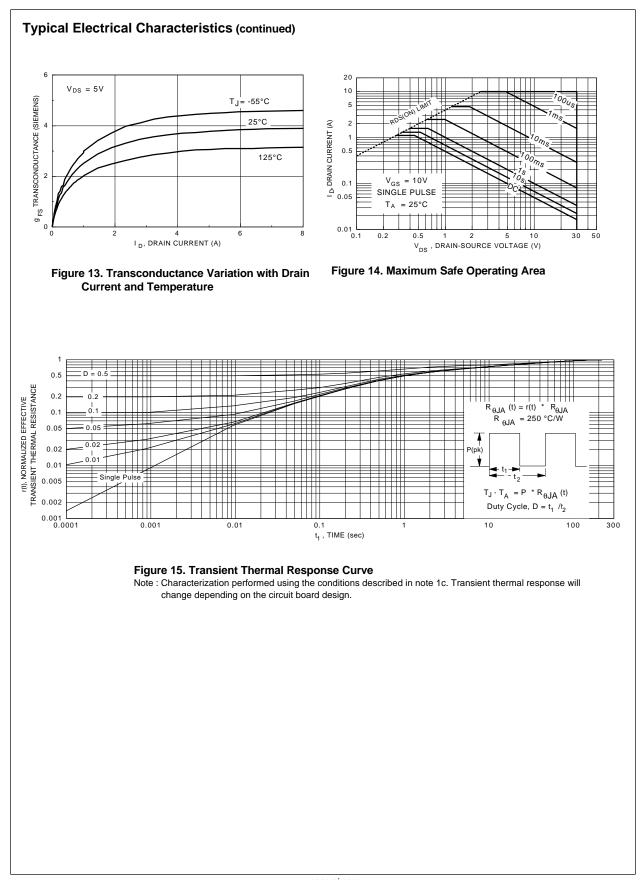
2. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%.



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